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1A, 50V - 600V Surface Mount Super Fast Rectifiers

FEATURES

- Glass passivated junction chip
- Ideal for automated placement
- Super fast recovery time for high efficiency
- Built-in strain relief
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition







DO-214AC (SMA)

MECHANICAL DATA

Case: DO-214AC (SMA)

Molding compound, UL flammability classification rating 94V-0

Moisture sensitivity level: level 1, per J-STD-020 Part No. with suffix "H" means AEC-Q101 qualified

Packing code with suffix "G" means green compound (halogen-free) **Terminal:** Matte tin plated leads, solderable per JESD22-B102

Meet JESD 201 class 2 whisker test **Polarity:** Indicated by cathode band **Weight:** 0.06 g (approximately)

DADAMETED	SYMBOL	ES	ES	ES	ES	ES	ES	ES	ES	UNIT
PARAMETER		1 A	1 B	1C	1 D	1F	1 G	1H	1J	
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	150	200	300	400	500	600	V
Maximum RMS voltage	V_{RMS}	35	70	105	140	210	280	350	420	V
Maximum DC blocking voltage	V_{DC}	50	100	150	200	300	400	500	600	V
Maximum average forward rectified current	I _{F(AV)}	1					Α			
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30					А			
Maximum instantaneous forward voltage (Note 1) @ 1 A	V _F	0.95 1.3		.3	1.7		٧			
Maximum reverse current @ rated V_R T_J =25°C T_J =125°C		5 100					μA			
Maximum reverse recovery time (Note 2)	t _{rr}	35						ns		
Typical junction capacitance (Note 3)	C _J	16 18			pF					
Typical thermal resistance	R _{eJL} R _{eJA}	35 85					°C/W			
Operating junction temperature range	TJ	- 55 to +150					°C			
Storage temperature range	T _{STG}	- 55 to +150						°C		

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Reverse Recovery Test Conditions: I_F =0.5A, I_R =1.0A, I_{RR} =0.25A

Note 3: Measured at 1 MHz and Applied V_R =4.0 Volts



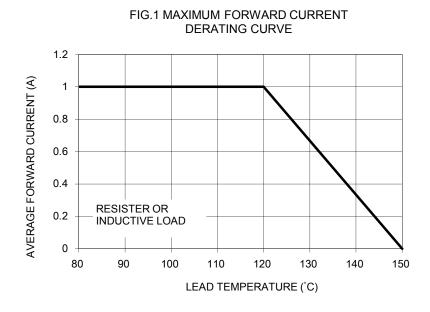
PART NO.	PART NO.	PACKING	PACKING CODE	PACKAGE	PACKING
	SUFFIX	CODE	SUFFIX		
		R3	₹2	SMA	1,800 / 7" Plastic reel
		R2		SMA	7,500 / 13" Paper reel
	н	M2		SMA	7,500 / 13" Plastic reel
ES1x	F3	G	Folded SMA	1,800 / 7" Plastic reel	
(Note 1)	(Note 1) F2 F4	F2	G	Folded SMA	7,500 / 13" Paper reel
		F4		Folded SMA	7,500 / 13" Plastic reel
N/A	E3		Clip SMA	1,800 / 7" Plastic reel	
	E2		Clip SMA	7,500 / 13" Plastic reel	

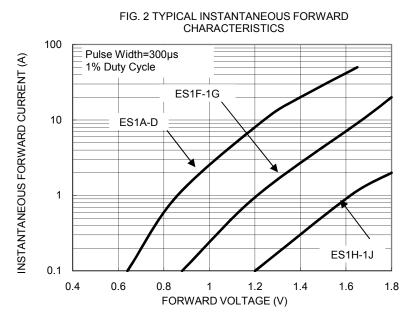
Note 1: "x" defines voltage from 50V (ES1A) to 600V (ES1J)

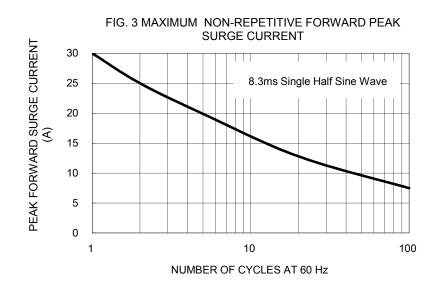
EXAMPLE					
PREFERRED PART NO.	PART NO.	PART NO. SUFFIX	PACKING CODE	PACKING CODE SUFFIX	DESCRIPTION
ES1JHR3G	ES1J	Ħ	R3	G	AEC-Q101 qualified Green compound

RATINGS AND CHARACTERISTICS CURVES

(T_A=25°C unless otherwise noted)







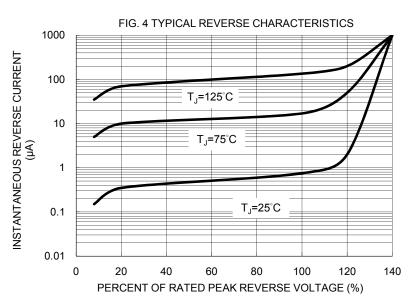




FIG. 5 TYPICAL JUNCTION CAPACITANCE

100

(bd)

ES1F-J

ES1F-J

f=1.0MHz

Vsig=50mVp-p

1

0.1

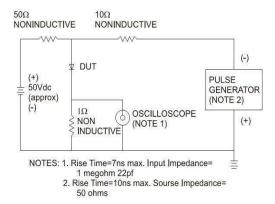
1

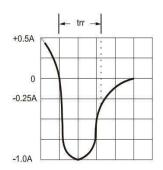
10

100

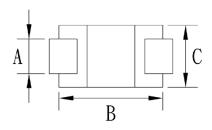
REVERSE VOLTAGE (V)

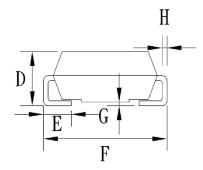
FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM





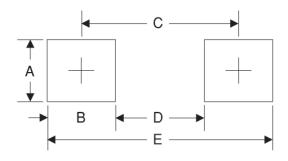
PACKAGE OUTLINE DIMENSIONS DO-214AC (SMA)





DIM.	Unit	(mm)	Unit (inch)		
DIIVI.	Min	Max	Min	Max	
Α	1.27	1.58	0.050	0.062	
В	4.06	4.60	0.160	0.181	
С	2.29	2.83	0.090	0.111	
D	1.99	2.50	0.078	0.098	
Е	0.90	1.41	0.035	0.056	
F	4.95	5.33	0.195	0.210	
G	0.10	0.20	0.004	0.008	
Н	0.15	0.31	0.006	0.012	

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
Α	1.68	0.066
В	1.52	0.060
С	3.93	0.155
D	2.41	0.095
Е	5.45	0.215

MARKING DIAGRAM



P/N = Specific Device Code G = Green Compound

YW = Date Code F = Factory Code



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